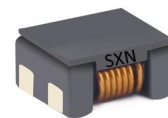


Common Mode Choke



SMCM Series Common Mode Line Filter



◆特征:

- 适用大电流的片式共模滤波器
- 所有系列产品的形状均控制在最小限度同时共模阻抗超过了300~1000(10MHz时)可大幅抑制共模噪音
- 产品的高度尺寸也被控制在较低水平能够适应不断小型轻量化的便携式设备的高密度化趋势
- 符合 RoHS,无卤和 REACH

◆用途:

- 用于应对电子设备的电源线噪音 (笔记本电, 伺服器, 电池, 等)
- 适合车载大电流电路
- 无线充电电源装置

◆环境:

- 工作温度: -40℃ 至+125℃ (包括线圈自身温升)

◆试验设备:

- 电感值:HP4274A 或同等仪器
- 电流:HP4284+42841A
- 阻抗:E4991+ HP16092 测试夹具
- 直流电阻: Chroma 16502 或同等仪器

◆产品型号:

Features:

- Chip common mode filter for large current applications
- The shape of all series products is controlled to a minimum and the common mode impedance exceeds 300~1000 (at 10MHz), which can greatly suppress common mode noise
- Compatible with high-density portable devices, which are always being made smaller and lighter, because the height has been reduced
- RoHS, Halogen Free and REACH Compliance

Applications:

- Power line noise countermeasure for electronic equipment (Notebook, server applications, Battery , etc.)
- Best for high current circuit such as car
- wireless charging and power device design

Environmental Data:

- Operating Temperature: -40℃ to +125℃ (Including coils self-temperature rise)

Test Equipment:

- L:HP4284A or HP4285A LCR meter or equivalent
- Isat & Irms: HP4284+42841A
- Impedance: E4991 analyzer with HP16092 test fixture
- DCR:Chroma 16502 or equivalent

Product Identification:

<u>SMCM</u>		<u>4520</u>	
①		②	
①			
类型 Type			
SMCM	贴片共模滤波器 SMT Common Mode Line Filter		

<u>701</u>		<u>T</u>
③		④
②		
外形尺寸(L×W×H) (mm) External Dimensions (L×W×H) (mm)		
4520	4.7×4.5×2.0	

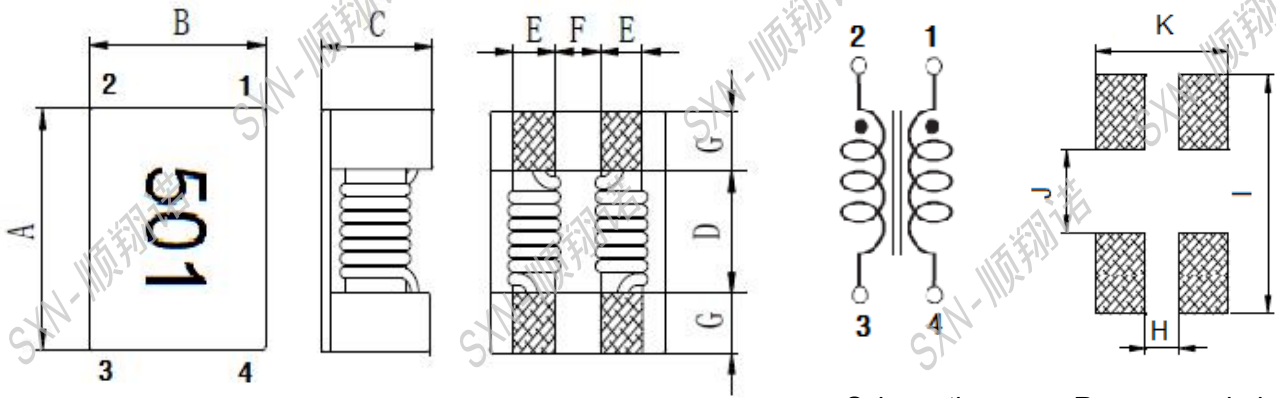
③
Impedance
700 Ω

④	
包装 Packing	
B	散装Bulk Package
T	编带Tape & Reel

◆外观尺寸:

Shape and Dimensions(dimensions are in mm):

● SMCM4520 Series



Schematic

Recommended Land Pattern

A	B	C	D	E	F	G	H	I	J	K
4.7±0.5	4.5±0.5	2.0 Max	2.7 Typ	0.8 Typ	1.25 Typ	1.0 Typ	1.0	6.0	2.0	3.0

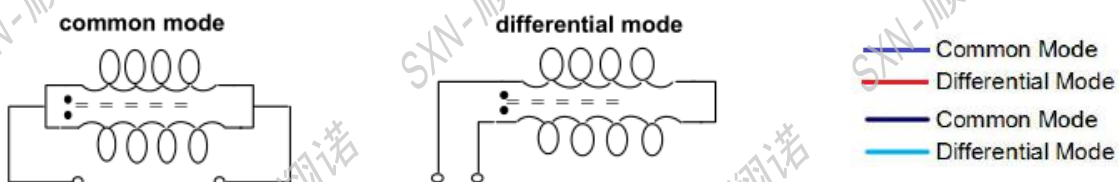
◆规格特性:

Specifications:

● SMCM4520 Series Electrical Characteristics (Electrical specifications at 25°C)

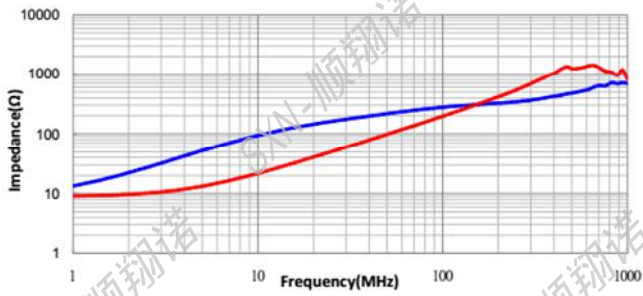
Part Number	Impedance (Ω) @100MHz		DC Resistance (mΩ) Max	Rated Current (A) Max	Rated Voltage (V) Max	Insulatio Resistance (MΩ) Min	Marking
	Min	Typ					
SMCM4520-900T	60	90	35	2.0	50	10M	900
SMCM4520-151T	90	150	40	1.9	50	10M	151
SMCM4520-231T	180	230	45	1.8	50	10M	231
SMCM4520-301T	200	300	45	1.7	50	10M	301
SMCM4520-421T	300	420	55	1.5	50	10M	401
SMCM4520-501T	350	500	57	1.3	50	10M	501
SMCM4520-701T	500	700	59	1.3	50	10M	701
SMCM4520-901T	650	900	68	1.3	50	10M	901
SMCM4520-102T	800	1000	68	1.3	50	10M	102
SMCM4520-122T	1000	1200	74	1.2	50	10M	122
SMCM4520-142T	1200	1400	81	1.2	50	10M	142
SMCM4520-152T	1300	1500	87	1.0	50	10M	152

● Circuit: Test Mode

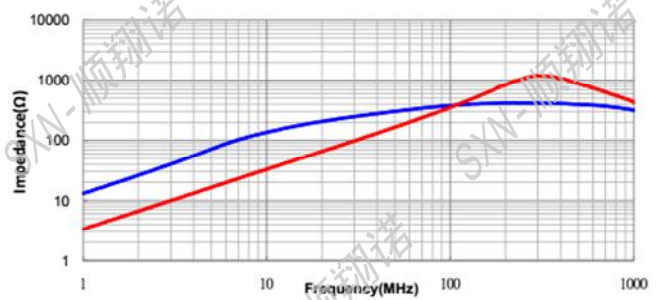


- Typical Impedance versus Frequency

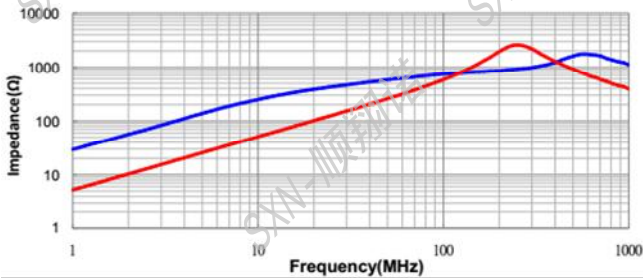
SMCM4520-301T



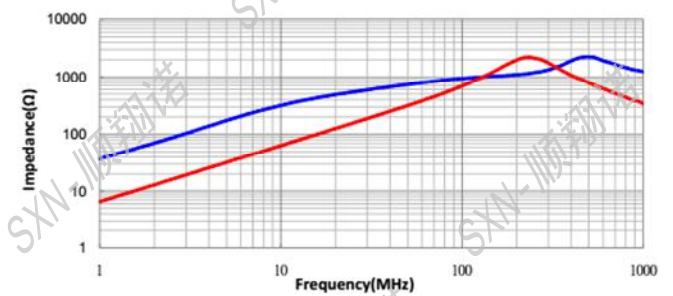
SMCM4520-421T



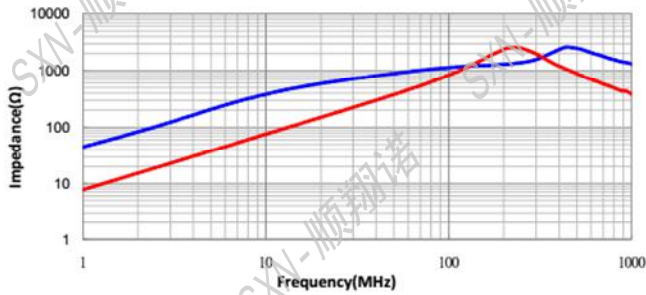
SMCM4520-701T



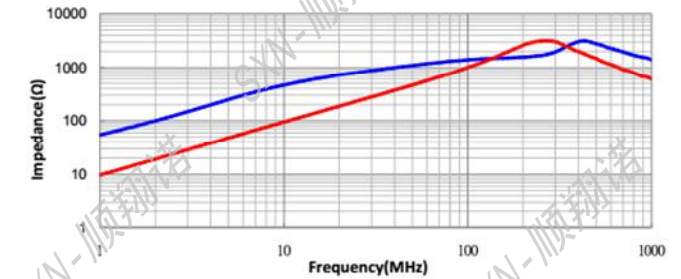
SMCM4520-102T



SMCM4520-122T



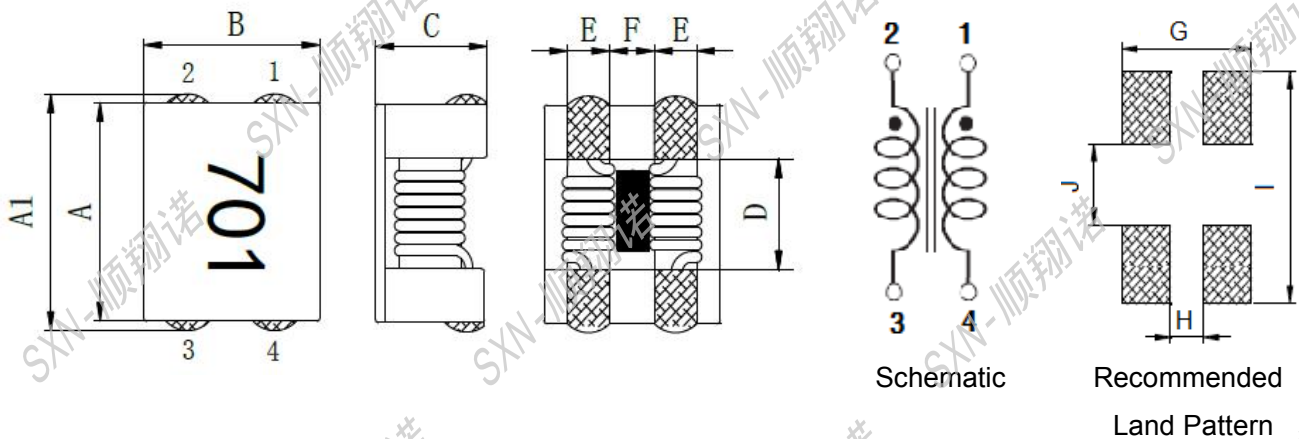
SMCM4520-142T



◆外观尺寸:

Shape and Dimensions(dimensions are in mm):

● SMCM7060、9070、1211 Series



P/N	A	A1	B	C	D	E	F	G	H	I	J
	±0.5	±0.5	±0.5	Max	Typ	Typ	Typ	Typ	Typ	Typ	Typ
SMCM7060	7.00	7.50	6.00	3.80	3.50	1.50	1.70	5.00	1.50	8.00	3.00
SMCM9070	9.00	9.50	7.00	4.80	5.60	1.50	1.70	5.50	1.50	10.50	5.00
SMCM1211	12.00	12.50	10.80	6.40	7.00	2.70	2.50	8.50	2.00	12.50	6.50

◆规格特性:

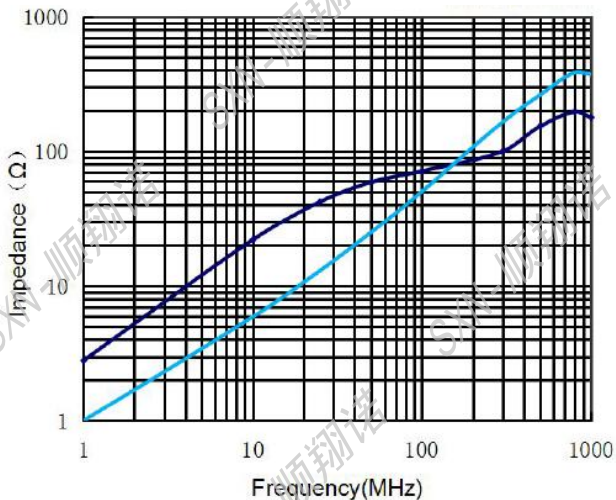
Specifications:

● SMCM7060 Series Electrical Characteristics (Electrical specifications at 25°C)

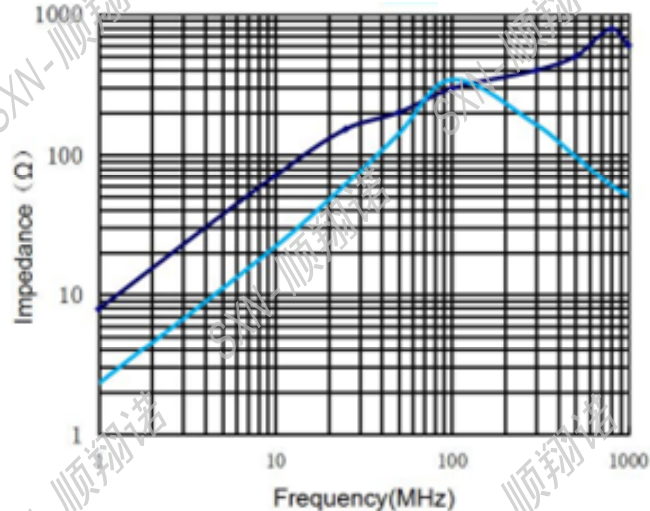
Part Number	Impedance (Ω) @100MHz		DC Resistance (m Ω) Max	Rated Current (A) Max	Rated Voltage (V) Max	Insulatio Resistance (M Ω) Min	Marking
	Min	Typ					
SMCM7060-400T	40	70	5	15.0	125	10M	400
SMCM7060-101T	100	140	10	9.0	125	10M	101
SMCM7060-301T	225	300	10	5.0	125	10M	301
SMCM7060-501T	275	450	10	5.0	125	10M	501
SMCM7060-601T	500	700	15	4.0	125	10M	601
SMCM7060-701T	500	700	15	4.0	125	10M	701
SMCM7060-102T	800	1020	17	3.0	125	10M	102
SMCM7060-132T	910	1300	21	2.5	125	10M	132
SMCM7060-272T	2000	2700	63	1.0	125	10M	272
SMCM7060-302T	2500	3000	75	0.9	125	10M	302

- Typical Impedance versus Frequency

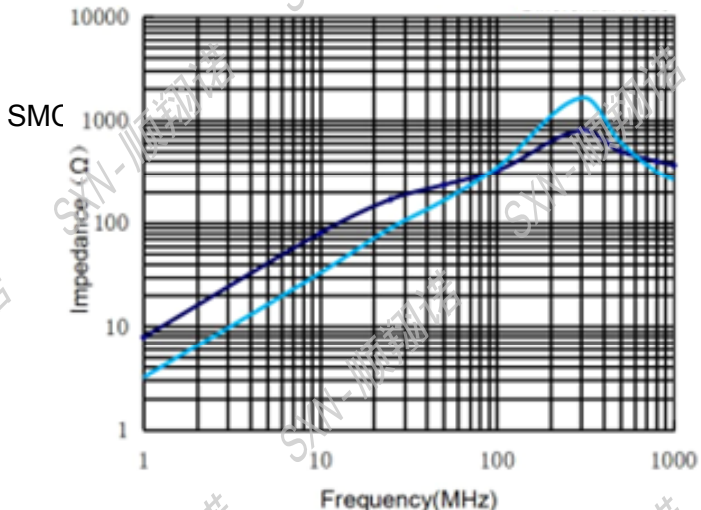
SMCM7060-400T



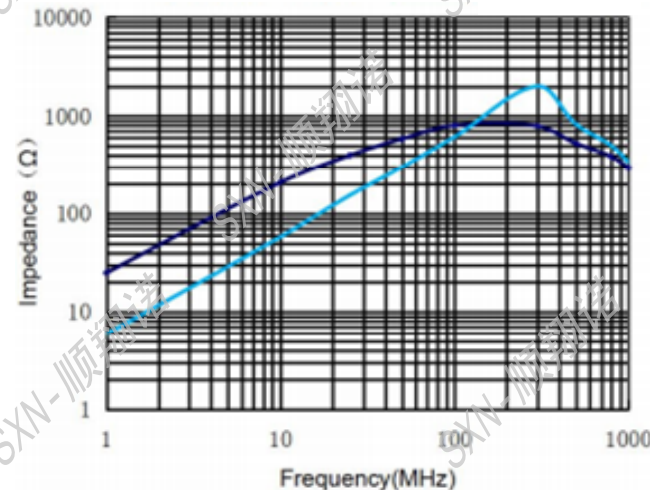
SMCM7060-101T



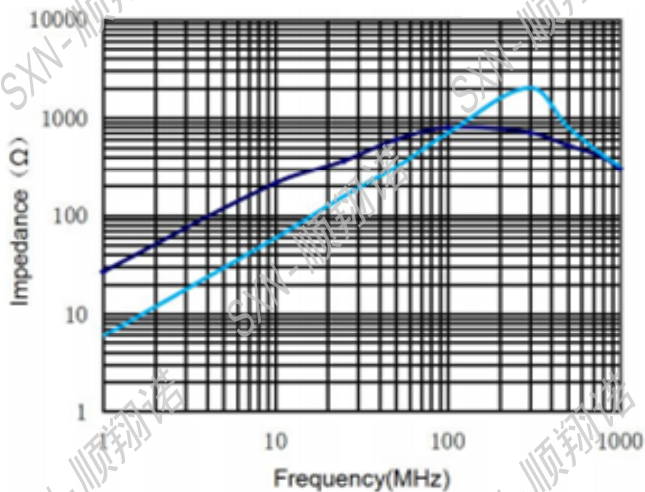
SMCM7060-301T



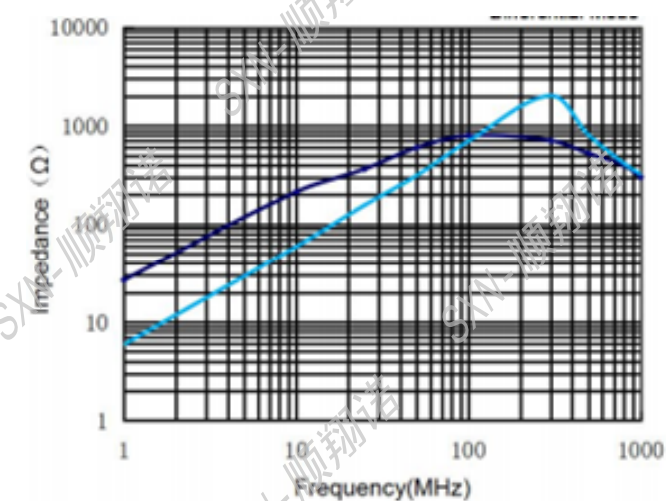
SMCM7060-501T



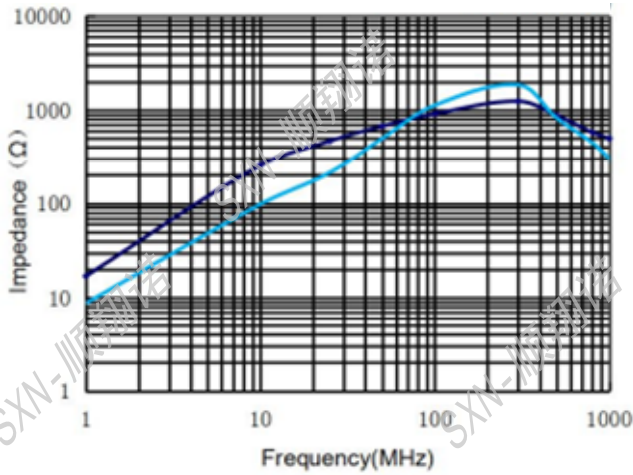
SMCM7060-601T



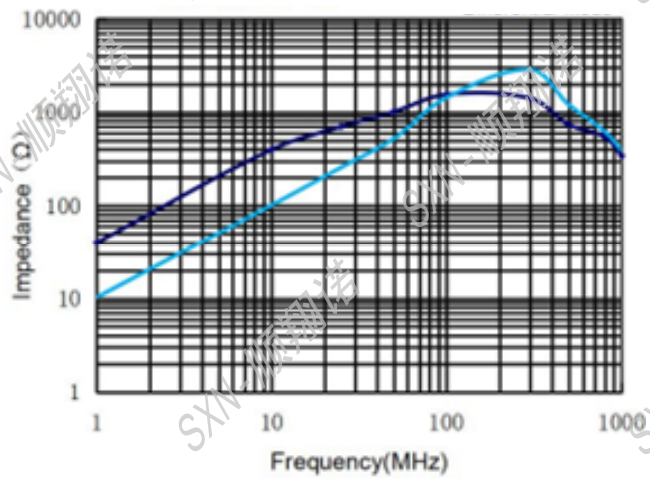
SMCM7060-701T



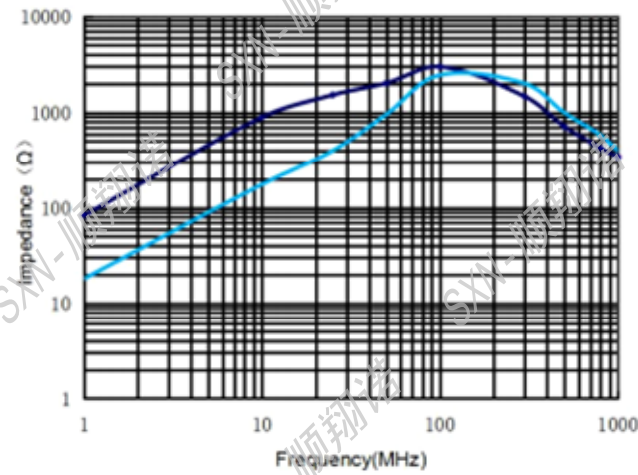
SMCM7060-102T



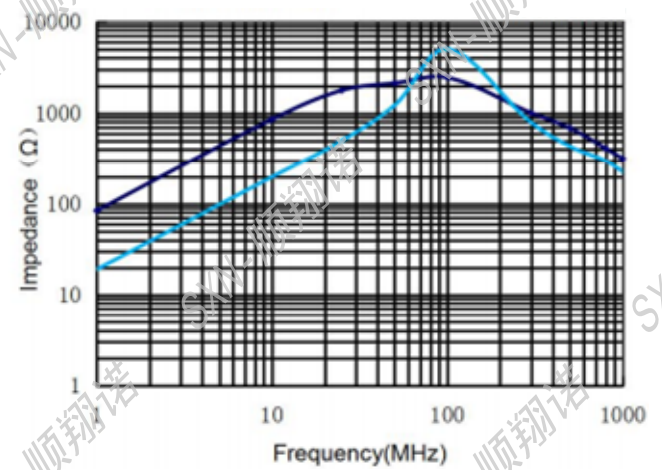
SMCM7060-132T



SMCM7060-272T



SMCM7060-302T

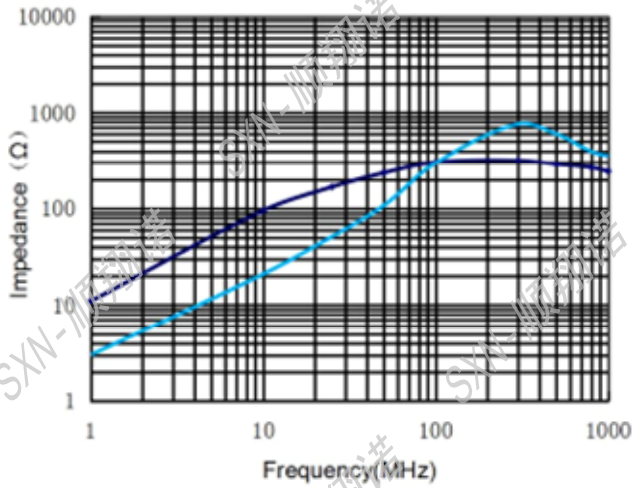


● SMCM9070 Series Electrical Characteristics (Electrical specifications at 25°C)

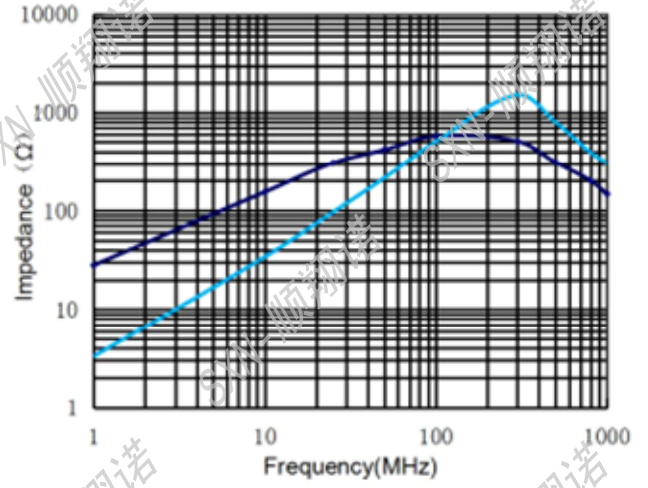
Part Number	Impedance (Ω) @100MHz		DC Resistance (mΩ) Max	Rated Current (A) Max	Rated Voltage (V) Max	Insulatio Resistance (MΩ) Min	Marking
	Min	Typ					
SMCM9070-301T	225	300	6	6.0	80	10M	301
SMCM9070-501T	450	600	8	5.5	80	10M	501
SMCM9070-701T	500	700	10	5.0	80	10M	701
SMCM9070-102T	750	1000	13	4.0	80	10M	102
SMCM9070-222T	1700	2200	50	3.0	80	10M	222
SMCM9070-272T	2000	2700	80	2.0	80	10M	272

- Typical Impedance versus Frequency

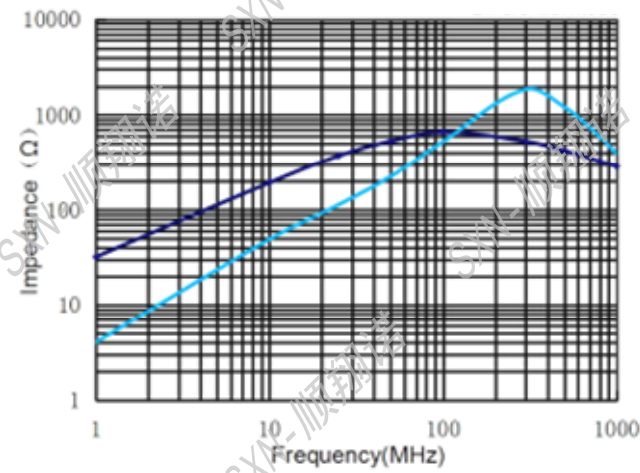
SMCM9070-301T



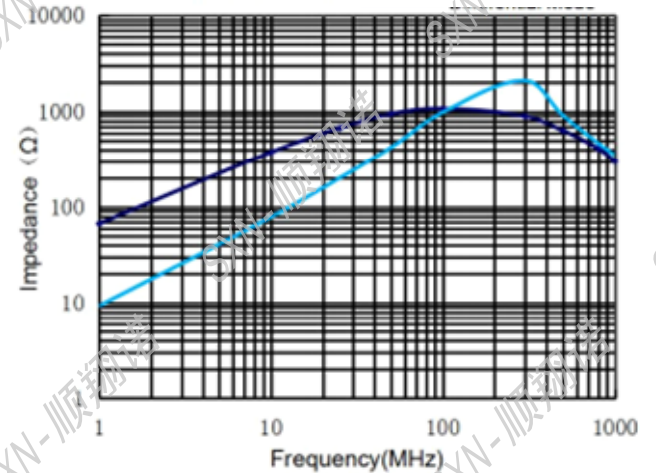
SMCM9070-501T



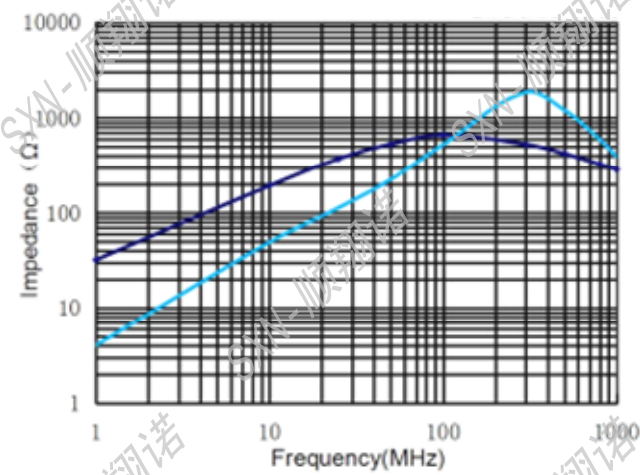
SMCM9070-701T



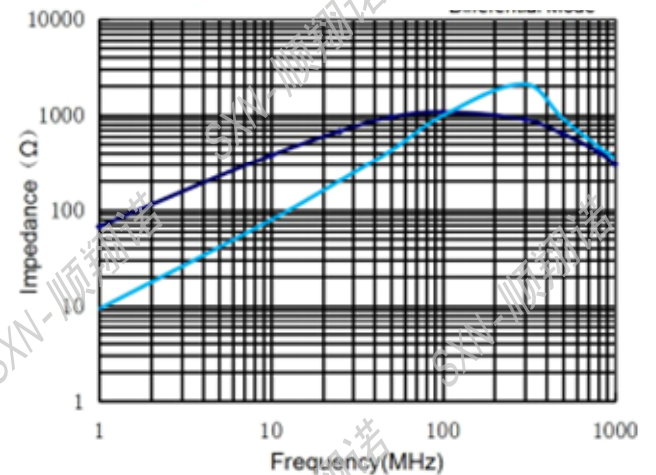
SMCM9070-102T



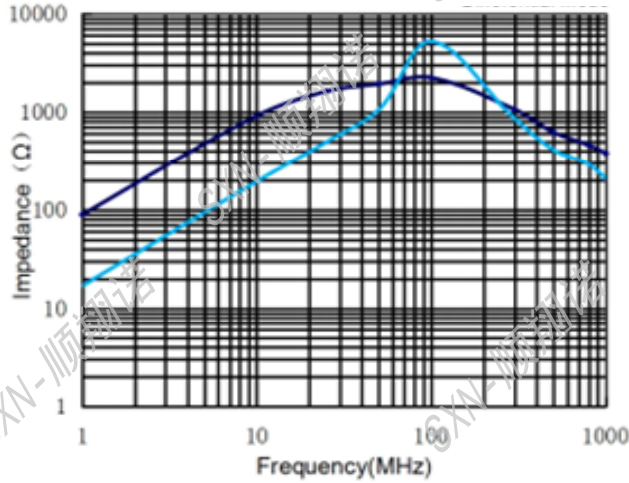
SMCM9070-701T



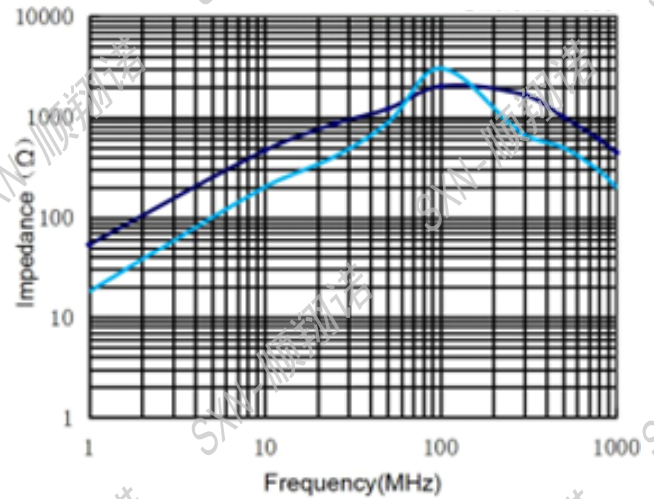
SMCM9070-102T



SMCM9070-222T



SMCM9070-272T



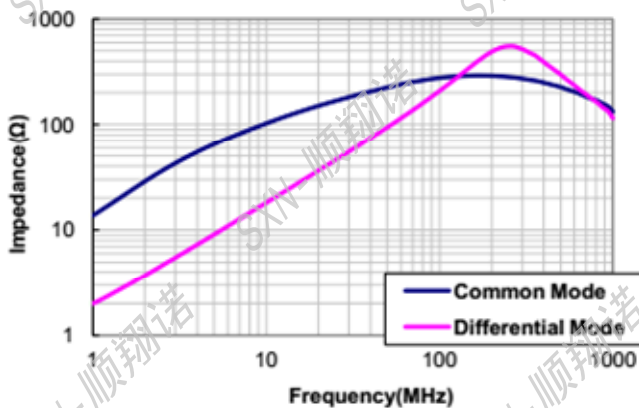
● SMCM1211 Series Electrical Characteristics (Electrical specifications at 25°C)

Part Number	Impedance (Ω) @100MHz		DC Resistance (mΩ) Max	Rated Current (A) Max	Rated Voltage (V) Max	Insulatio Resistance (MΩ) Min	Marking
	Min	Typ					
SMCM1211-800T	80	230	2.0	10.0	125	10M	301
SMCM1211-701T	500	700	6.0	8.0	125	10M	701
SMCM1211-801T	600	800	8.0	8.0	125	10M	801
SMCM1211-102T	750	1000	14	6.0	125	10M	102
SMCM1211-222T	2200	2500	35	1.8	125	10M	222
SMCM1211-272T	2300	2700	50	1.5	125	10M	272

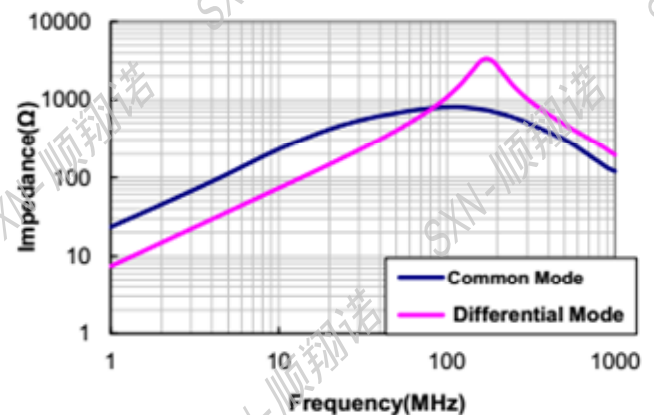
● Rated Current: the actual value of DC current when the temperature rise is ΔT 40°C ($T_a=25^\circ\text{C}$).

● Typical Impedance versus Frequency

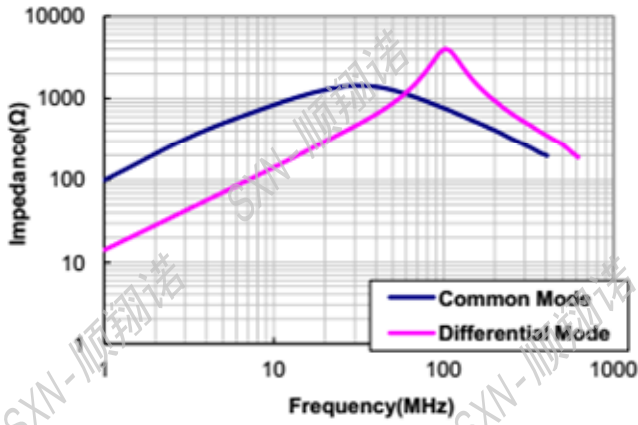
SMCM1211-800T



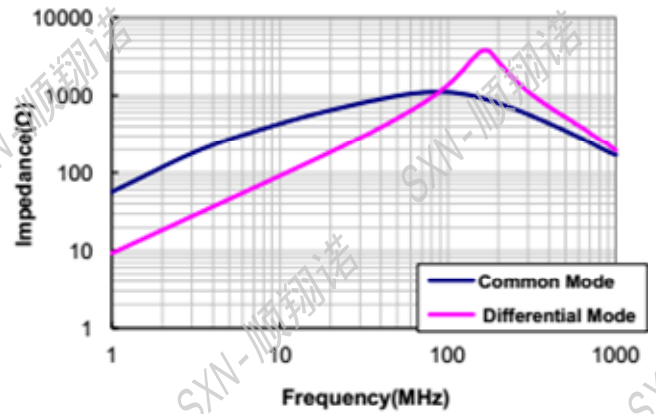
SMCM1211-701T



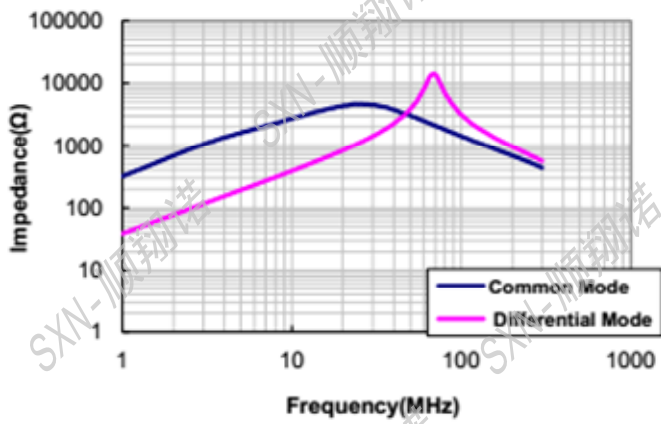
SMCM1211-801T



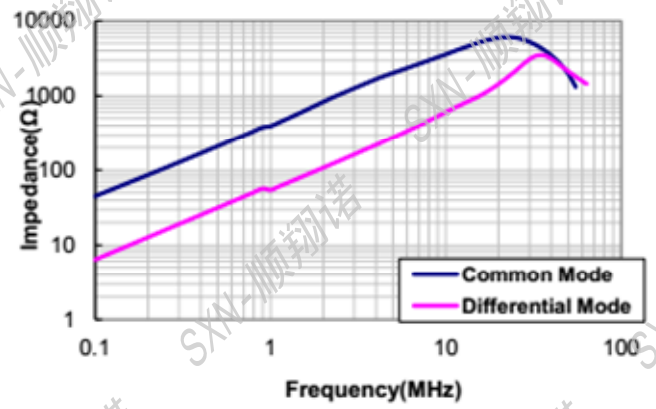
SMCM1211-102T



SMCM1211-222T



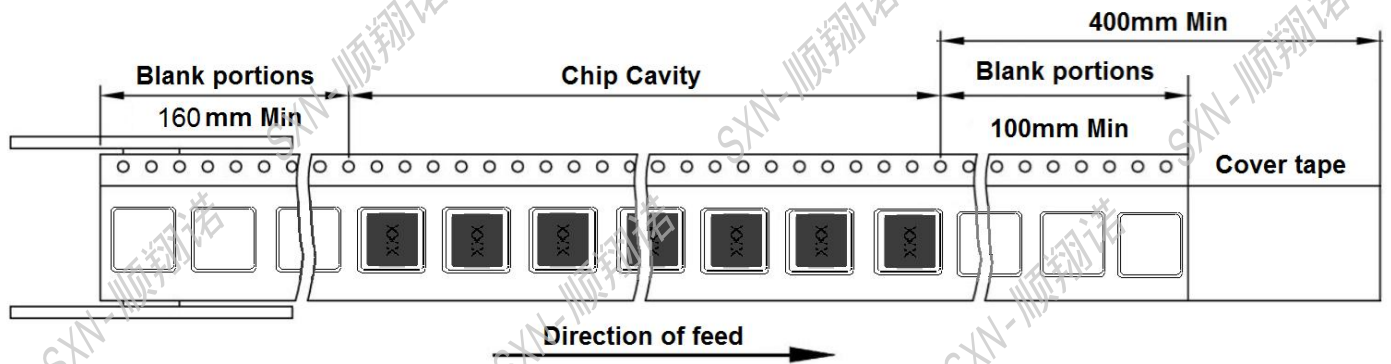
SMCM1211-272T



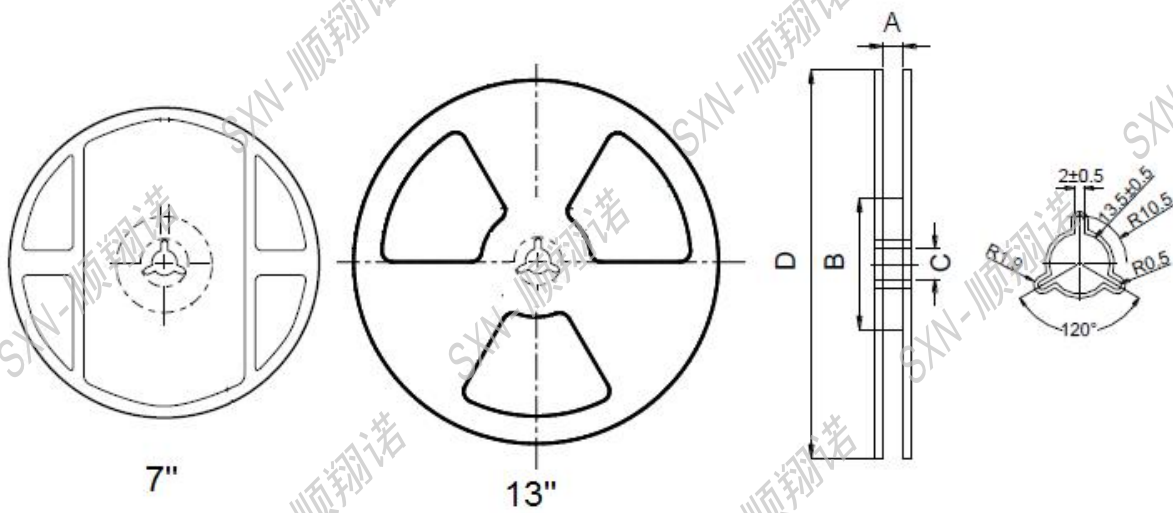
◆ 产品包装:

Packaging:

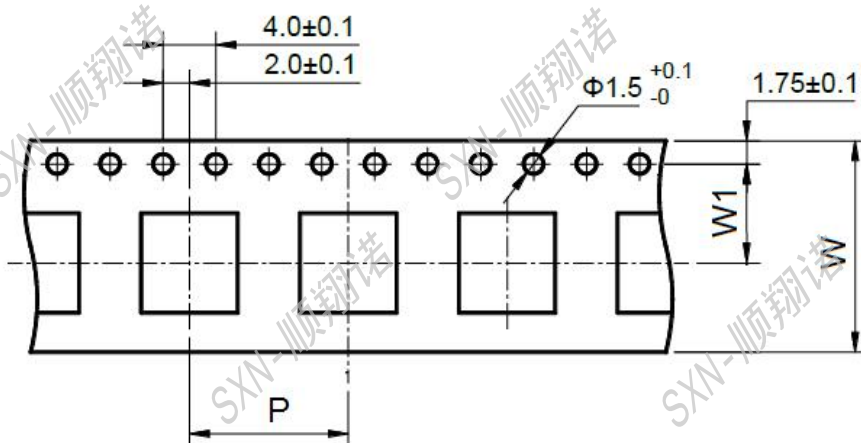
● Tape and Reel Specifications: (Dimensions are in mm)



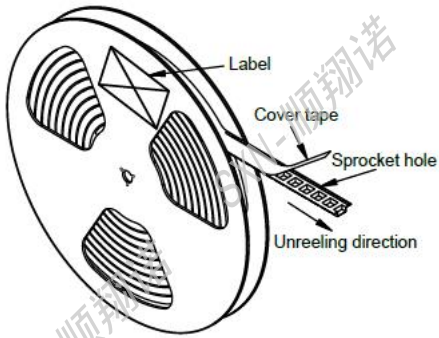
● Reel Dimensions (mm)



● Tape Dimension (mm)

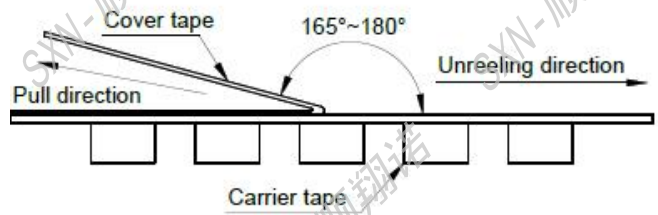


• Cover tape peel off condition

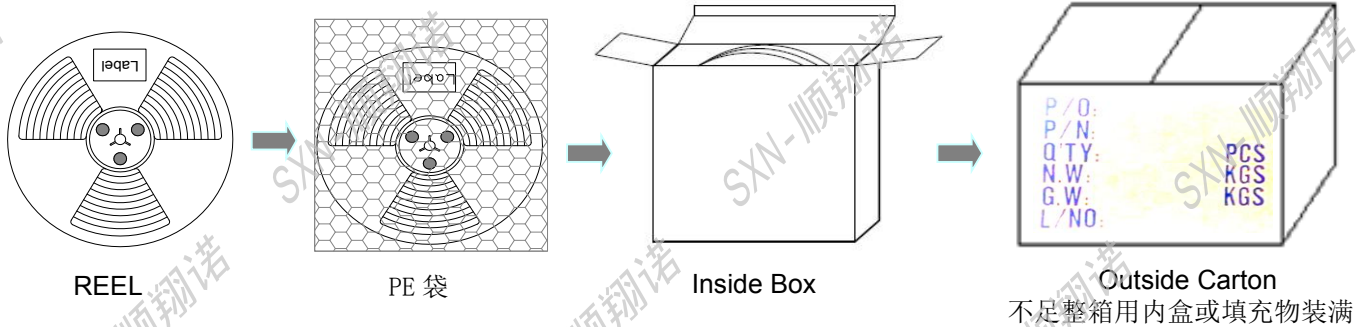


a) Cover tape peel force shall be 10 to 120g

b) Noodle strip peeling angle 165° to 180°



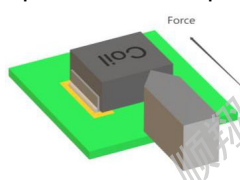

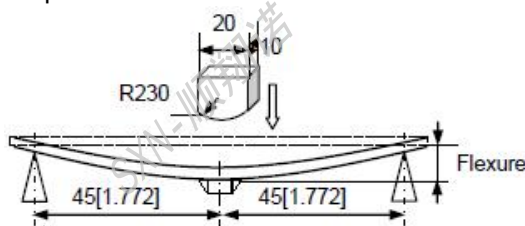
• Packing quantity

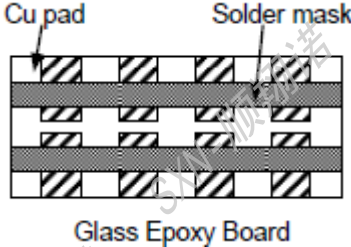
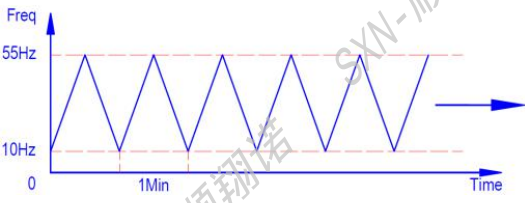
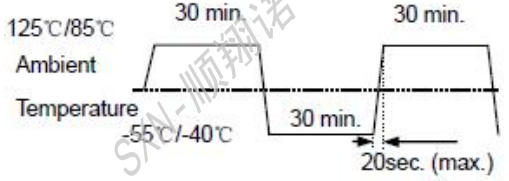
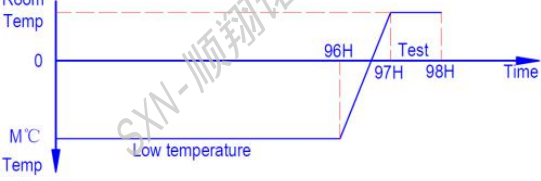


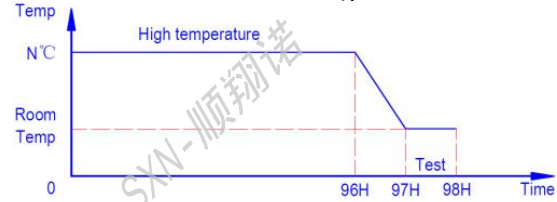
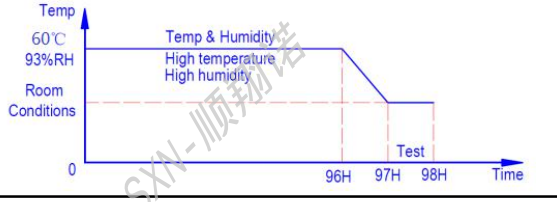
Part No.	Tape Dimension			Reel Dimensions				REEL (PCS)	Inside Box(PCS)	Outside Carton(PCS)
	W	P	W1	A	B	C	D			
SMCM4520	12.0	8.0	5.5	12.4	60	13	180	1000	4000	40,000
SMCM7060	16.0	12.0	7.5	16.4	60	13	330	1500	4500	2,2500
SMCM9070	24.0	16.0	11.5	24.4	60	13	330	700	1400	7000
SMCM1211	24.0	16.0	11.5	24.4	60	13	330	500	1000	5000

◆可靠性测试:

Reliability Testing:

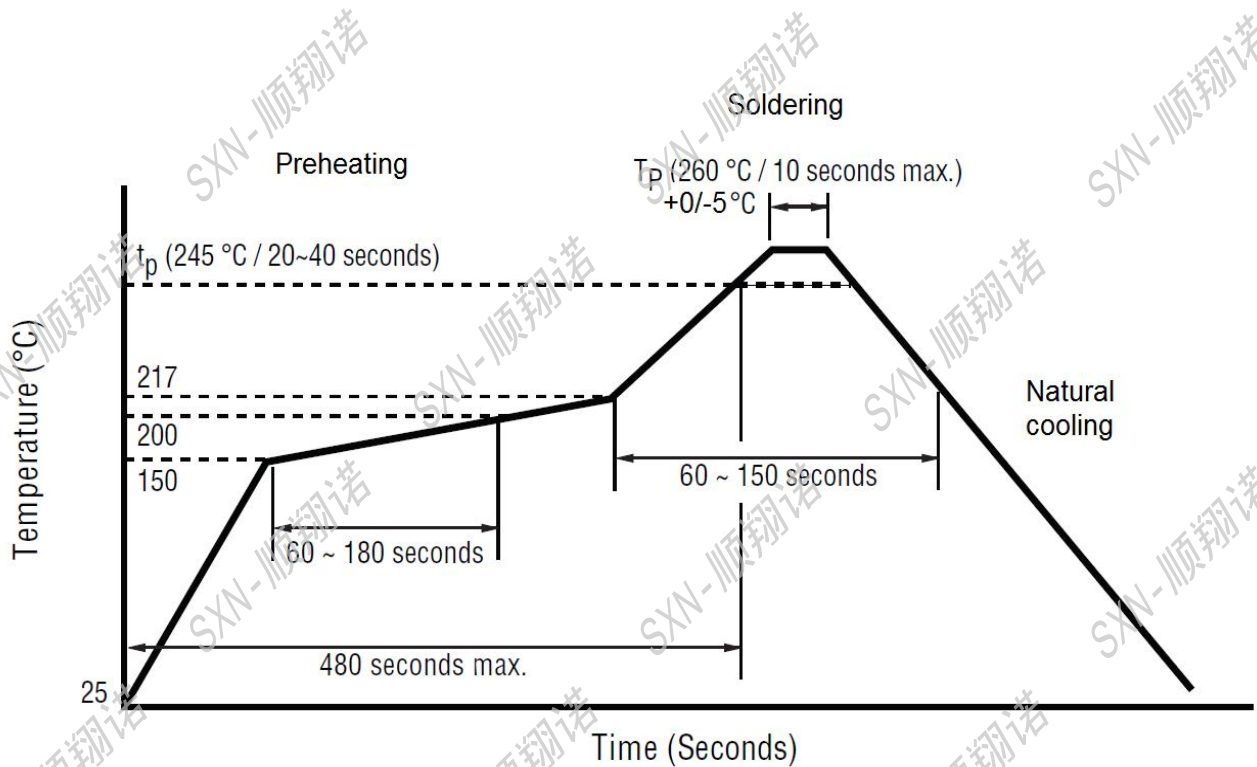
Items	Requirements	Test Methods and Remarks
Terminal Strength Reference documents: GB/T 2423.60-2008 端子强度(SMT)	1. Pulling test: Define: A: sectional area of terminal $A \leq 8\text{mm}^2$ force $\geq 5\text{N}$ time: 30sec $8\text{mm}^2 < A \leq 20\text{mm}^2$ force $\geq 10\text{N}$ time: 10sec $20\text{mm}^2 < A$ force $\geq 20\text{N}$ time: 10sec 2. Solder paste thickness: 0.12mm 3. Meet the above requirements without any loose terminal	Solder the inductor to the testing jig using leadfree solder. Then apply a force in the direction shown Keep time: $10 \pm 1\text{s}$ Speed: 1.0mm/s. 
Terminal Strength Reference documents: GB/T 2423.60-2008 端子强度(DIP)	1. Terminal diameter (d) mm $0.35 < d \leq 0.50$ Applied force: 5N Duration: 10sec 2. Terminal diameter (d) mm $0.50 < d \leq 0.80$ Applied force: 10N Duration: 10sec 3. Terminal diameter (d) mm $0.80 < d \leq 1.25$ Applied force: 20N Duration: 10sec 4. Terminal diameter (d) mm $D > 1.25$ Applied force: 40N Duration: 10sec 5. Meet the above requirements without any loose terminal.	Pull Force: the force shall be applied gradually to the terminal and then maintained for 10 seconds. 
Resistance to Flexure JIS C 5321:1997 抗弯曲性试验	1. No visible mechanical damage.	1. Solder the inductor to the test jig (glass epoxy board) 2. shown in Using a leadfree solder. Then apply a force in the direction shown 3. Flexure: 2mm. 4. Pressurizing Speed: 0.5mm/sec. 5. Keep time: 30 sec. 
Dropping Reference documents: GB/T 2423.7-2018 落下试验	1. No case deformation or change in appearance. 2. No short and no open.	1. Drop the packaged products from 1m high in 1 angle, 3 ridges and 6 surfaces, twice in each direction.
Solderability Reference documents: GB/T 2423.28-2005 可焊性试验	1. No visible mechanical damage. 2. Wetting shall exceed 75% coverage for 3. Terminals must have 95% minimum solder coverage	1. Solder temperature: $240 \pm 2^\circ\text{C}$ 2. Duration: 3 sec. 3. Solder: Sn/3.0Ag/0.5Cu. 4. Flux: 25% Resin and 75% ethanol in weight

Items	Requirements	Test Methods and Remarks
<p>Vibration</p> <p>Reference documents: GB/T 2423.10-2019</p> <p>振動試驗</p>	<p>1.No visible mechanical damage.</p> <p>2. Inductance change: Within $\pm 10\%$.</p> <p>3. Q factor change: Within $\pm 20\%$.</p> 	<p>1.Solder the inductor to the testing jig (glass epoxy boardshown in) using leadfree solder.</p> <p>2.The inductor shall be subjected to a simple harmonic motion having total amplitude of 1.5mm, the frequency being varied uniformly between the approximate limits of 10 and 55 Hz.</p> <p>3.The frequency range from 10 to 55 Hz and return to 10 Hz shall be traversed in approximately 1 minute. This motion shall be applied for a period of 2 hours in each 3 mutually perpendicular directions(total of 6 hours).</p> 
<p>Thermal Shock</p> <p>Reference documents: GB/T 2423.22-2012</p> <p>Method Na</p> <p>冷热冲击试验</p>	<p>1.No visible mechanical damage.</p> <p>2. Inductance change: Within $\pm 10\%$.(Mn-Zn: Within $\cong 30\%$)</p> <p>3.Q factor change: Within $\pm 20\%$.</p>	<p>1.Start at (85~125℃) for T time, rush to (-55~40℃) for T time as one cycle, go through 100 cycles.</p> <p>2.Transforming interval: Max. 20 sec.</p> <p>3.Tested cycle: 100 cycles.</p> <p>4.The chip shall be stabilized at normal condition for 1~2 hours</p> 
<p>Low temperature Storage</p> <p>Reference documents: GB/T 2423.1-2008</p> <p>Method Ab</p> <p>低温储存试验</p>	<p>1.No visible mechanical damage.</p> <p>2. Inductance change: Within $\pm 10\%$.(Mn-Zn: Within $\cong 30\%$)</p> <p>3.Q factor change: Within $\pm 20\%$.</p>	<p>1.Temperature:M(-55~-40$\pm 2^\circ\text{C}$)</p> <p>2.Duration: 96± 2 hours</p> <p>3.The chip shall be stabilized at normal condition for 1~2 hours before measuring.</p> 

Items	Requirements	Test Methods and Remarks
High temperature Storage Reference documents: GB/T 2423.2-2008 Method Bb 高温储存试验	1.No visible mechanical damage. 2. Inductance change: Within $\pm 10\%$.(Mn-Zn: Within $\cong 30\%$) 3.Q factor change: Within $\pm 20\%$.	1.Temperature:N($125\sim 85\pm 2^{\circ}\text{C}$). 2.Duration: 96 ± 2 hours 3.The chip shall be stabilized at normal condition for 1~2 hours before measuring. 
Damp Heat (Steady States) Reference documents: GB/T 2423.3-2016 恒定湿热试验	1.No visible mechanical damage. 2. Inductance change: Within $\pm 10\%$.(Mn-Zn: Within $\cong 30\%$) 3. Q factor change: Within $\pm 20\%$.	1.Temperature: $60\pm 2^{\circ}\text{C}$ 2.Humidity: 90% to 95% RH. 3.Duration: 96 ± 2 hours. 4.The chip shall be stabilized at normal condition for 1~2 hours before measuring. 
Heat endurance of Reflow soldering Reference documents: GJB 360B-2009 回流焊耐热性试验	1.No significant defects in appearance. 2. $\Delta L/L \cong 10\%$ (Mn-Zn: $\Delta L/L \cong 30\%$) 3. $\Delta Q/Q \cong 30\%$ (SMD series only) 4. $\Delta DCR/DCR \cong 10\%$	1.Refer to the above reflow curve and go through the reflow for twice. 2.The peak temperature : $260+0/-5^{\circ}\text{C}$
Resistance to solvent test Reference documents: IEC 68-2-45:1993 耐溶剂性试验	No case deformation or change in appearance or obliteration of marking	To dip parts into IPA solvent for 5 ± 0.5 Min, then drying them at room temp for 5Min, at last, to brushing making 10 times.
Overload test Reference documents: JIS C5311-6.13 过负荷试验	1.During the test no smoke, no peculiar, smell, no fire 2.The characteristic is normal after test	Apply twice as rated current for 5 minutes.
voltage resistance test Reference documents: MIL-STD-202G Method 301 绝缘耐压测试	1.During the test no breakdown 2.The characteristic is normal after test	1. For parts with two coils 2. DC1000V, Current: 1mA, Time: 1Min. 3. Refer to catalogue of specific products

◆推荐回流焊温度曲线

Recommended reflow soldering curve:



The recommended reflow conditions as above graph, is set according to our soldering equipment. DUE to various manufactures may have different reflow soldering equipment, products, process conditions, set methods. And so on, when setting the reflow conditions, Please adjust and confirm according to users' environment/equipment.

使用注意事项

REMINDERS FOR USING THESE PRODUCTS



- 保存时间为12 个月以内，保存条件（温度5~40°C以下、湿度35 ~ 66%RH 以下），需充分注意。若超过保存时间，端子电极的可焊性将可能老化。

The storage period is within 12 months. Be sure to follow the storage conditions (temperature: 5~40°C, humidity: 35 to 65% RH or less). If the storage period elapses, the soldering of the terminal electrodes may deteriorate.

- 请勿在气体腐蚀环境（盐、酸、碱等）下使用和保存。

Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).

- 手上的油脂会导致可焊性降低，应避免用手直接接触端子。

Don't touch electrodes directly with bare hands as oil secretions may inhibit soldering. Always ensure optimum conditions for soldering.

- 请小心轻拿轻放，避免由于产品的跌落或取出不当而导致的损坏。

Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.

- 端子过度弯曲会导致断线，请不要过度弯曲端子。

Don't bend the terminals with excessive stress in case of any wire fracture.

- 不要清洗产品，如需要清洗时请联系我司。

Don't rinse coils by yourself and please contact SXN if necessary.

- 请勿将本产品靠近磁铁或带有磁力的物体

Don't expose the products to magnets or magnetic fields

- 在实施焊接前，请务必进行预热。预热温度与焊接温度及芯片温度的温度差要在150°C 以内。

Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.

- 安装后的焊接修正应在规格书规定的条件范围内。若加热过度可能导致短路、性能降低、寿命减少。

Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.

- 装置会因通电而自我发热（温度上升），因此在热设计方面需留有充分余地。

Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.

- 非磁屏蔽型在基板设计时需注意配置线圈，受到电磁干扰可能会导致误动作。

Carefully lay out the coil for the circuit board design of the non-magnetic shield type. A malfunction may occur due to magnetic interference.

- 当本公司产品使用在一般电子设备以外的场合，如：车载、医疗设备、军用、航空航天等，请务必联系本公司营业部门，如超出本公司产品使用条件而引起的机器故障时，本公司概不负责。

If SXN product will be applied in area like automotive product, medical equipment, military and aerospace except generalelectronic device, please keep SXN sales informed in advance. SXN shall not be held liable for any malfunction or breakdown caused by using product in the condition which is inconsistent with that recommended by SXN.

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